

ASSIGNMENT

WHEREAS, We, Mitsugu Furutani, a citizen of Japan, having an address at c/o Sumitomo Wiring Systems, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510 JAPAN; Keigo Atsumi, a citizen of Japan, having an address at c/o Sumitomo Wiring Systems, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510 JAPAN; Masahiko Aoyama, a citizen of Japan, having an address at c/o Sumitomo Wiring Systems, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510 JAPAN; and Hitoshi Okumura, a citizen of Japan, having an address at c/o Sumitomo Wiring Systems, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510 JAPAN, have invented certain new and useful improvements in a **TERMINAL FITTING** for which an application for Letters Patent of the United States was filed on December 2, 1997, and accorded serial number 08/982,443; and

WHEREAS, Sumitomo Wiring Systems, Ltd., a corporation duly organized under the laws of Japan having a place of business at 1-14 Nishisuehiro-cho, Yokkaichi-City, Mie, 510 Japan, is desirous of acquiring the entire right, title and interest in and to the aforesaid invention and in and to any Letters Patent of the United States which may be granted therefor;

NOW THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we, the said Mitsugu Furutani, Keigo Atsumi, Masahiko Aoyama, and Hitoshi Okumura, by these presents do sell, assign, and transfer unto Sumitomo Wiring Systems, Ltd., its successors, legal representatives and assigns, the full and exclusive right to the said invention as described in the said application, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and in and to any and all divisions, reissues, continuations and extensions thereof;

AND WE HEREBY authorize and request the Commissioner of Patents and Trademarks to issue all said Letters Patent to said assignee;

AND WE HEREBY warrant and covenant that we have full right to convey the entire interest herein assigned and that we have not executed and will not execute any instrument or assignment in conflict herewith;

AND WE HEREBY agree to communicate to said assignee or its representatives any facts known to us respecting said invention, to execute all divisional, continuation, and reissue applications, sign all lawful documents and make all rightful oaths relating to said invention or otherwise to secure the title thereto to said assignee, and to testify in any judicial or administrative proceeding and generally do everything possible to aid the said assignee to obtain and enforce said Letters Patent in the United States when requested so to do by said assignee.

IN WITNESS WHEREOF, we have hereunto set our hand and seal.

February 10, 1998
Date

Mitsugu Furutani
Mitsugu FURUTANI

February 10, 1998
Date

Keigo Atsumi
Keigo ATSUMI

February 10, 1998
Date

Masahiko Aoyama
Masahiko AOYAMA

February 10, 1998
Date

Hitoshi Okumura
Hitoshi OKUMURA

WITNESSES:

Masakuni Kasugai
Shintaro Hayashi